## **LV5710GP**

## **Bi-CMOS LSI**

# **Power Supply for Charge Pump for Camera Sensor**



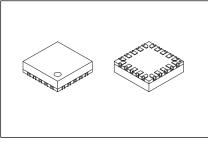
http://onsemi.com

#### Overview

The LV5710GP is power supply for charge pump for camera sensor.

## **Functions**

- Regulating the 5V input by boosting it three-fold with the charge pump to the specified voltage.
- Output voltage variable with external resistor.
- Soft start function incorporated, which reduces the rush current at start of charge pump.
- Timer-latch type short-circuit protective function incorporated.



VCT20 3x3, 0.5P

## **Specifications**

## **Absolute Maximum Ratings** at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V <sub>DD</sub> max		6.0	V
Allowable power dissipation	Pd max	with specified substrate *	0.55	W
Operating temperature	Topr		-20 to +80	°C
Storage temperature	Tstg		-40 to +125	°C

<sup>\*:</sup> Specified substrate: 114.3mm×76.1mm×1.6mm, glass epoxy board

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## Allowable Operating Ratings at Ta = 25°C

D	O: ::bl	O and this are		Ratings		Unit
Parameter	Symbol	Symbol Conditions	min	typ	max	
Supply voltage	$V_{DD}$		4.5		5.5	V
Input "H" voltage	V <sub>IN</sub> H	EN pin	1.5		$V_{DD}$	V
Input "L" voltage	V <sub>IN</sub> L	EN pin	-0.1		0.4	V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### ORDERING INFORMATION

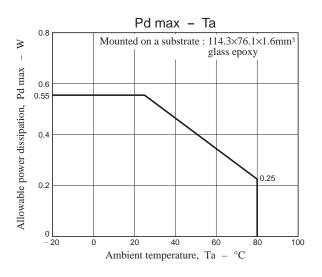
See detailed ordering and shipping information on page 7 of this data sheet.

## **LV5710GP**

 $\textbf{Electrical Characteristics} \ at \ Ta = 25^{\circ}C, \ V_{DD} = 5V, \ I_{OUT} = 30 \text{mA}, \ S0 = L, \ S1 = L, \ Unless \ otherwise \ specified$ 

Parameter	Cumbal	Conditions		Ratings		Unit	
Parameter	Symbol	Symbol Conditions		typ	max	Unit	
Circuit current drain	I <sub>DD</sub> 1	EN = L			1	μΑ	
	I <sub>DD</sub> 2	EN = H No load		12	18	mA	
Output load current	I <sub>O</sub> ave	At V <sub>OUT</sub> = 12V setting			30	mA	
Reference voltage	VREF	V <sub>DD</sub> = 4.5 to 5.5V	1.285	1.305	1.325	V	
		Ta = −20°C to +80°C, Design value	1.279		1.331	V	
Output voltage at OFF	VOFF	After capacitive discharge	-50	0	50	mV	
Protective circuit masking time	Tmask	Masking time from detection of short-circuit to IC OFF		18	33	ms	
Short-circuit protective current	l <sub>lim</sub>		35	50	65	mA	
Short-circuit protective voltage	V <sub>lim</sub>		82.5	87.5	92.5	%	
SS end time	TSSEND	Time from EN = H to regulator SS OFF Ta = -20°C to +80°C Design value			10	ms	
RO load regulation	ΔRO	Load 1mA → 30mA		30	40	mV	
Input pin current	lin	Pins EN	30	40	50	μΑ	
		S0 and S1 pins			1	μА	
Power efficiency	Peff	CP+regulator		70		%	
Rush current	Irush	No load			300	mA	
Oscillation frequency	f clk		1.4	1.8	2.3	MHz	

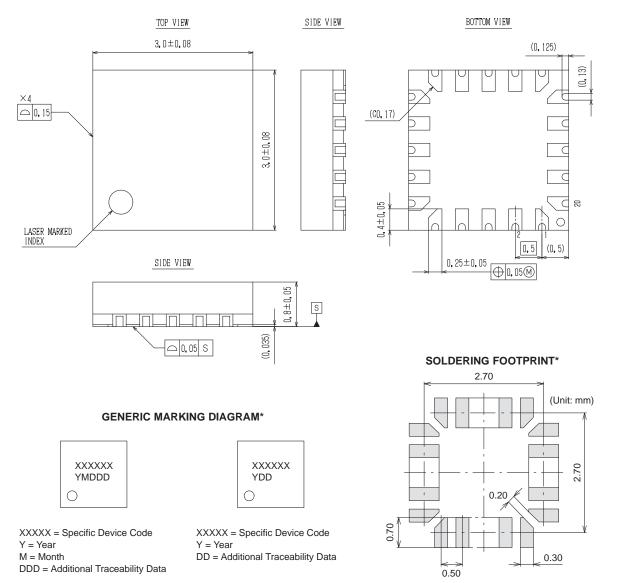
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



## **Package Dimensions**

unit: mm

VCT20 3x3, 0.5P CASE 601AB ISSUE A

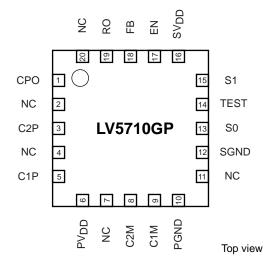


<sup>\*</sup>This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present.

NOTE: The measurements are not to guarantee but for reference only.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

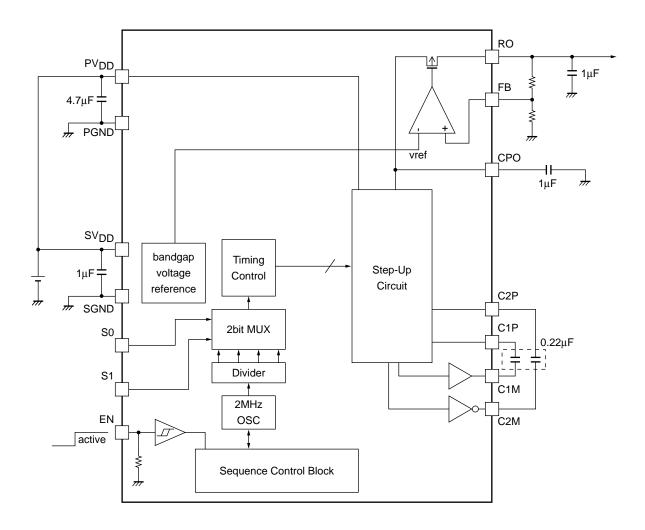
## **Pin Assignment**



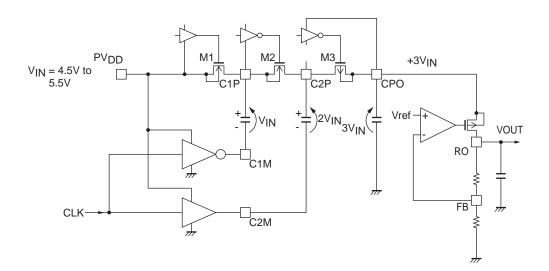
## **Pin Function**

Pin No.	Name	Function	
1	CPO	Boost voltage output (6V <sub>DD</sub> or 5V <sub>DD</sub> )	
2	NC		
3	C2P	Boost capacitor connection pin (charge transfer side)	
4	NC		
5	C1P	Boost capacitor connection pin (charge transfer side)	
6	$PV_{DD}$	Power system V <sub>DD</sub> pin	
7	NC		
8	C2M	Boost capacitor connection pin (driver side)	
9	C1M	Boost capacitor connection pin (driver side)	
10	PGND	Power GND pin for the charge pump	
11	NC		
12	SGND	Small signal system GND pin	
13	S0	Charge pump frequency changeover pin	
14	TEST	Test pin (open or short-circuited to GND)	
15	S1	Charge pump frequency changeover pin	
16	sv <sub>DD</sub>	Small signal system V <sub>DD</sub> pin	
17	EN	System enable pin (Hi active)	
18	FB	Regulator FB pin	
19	RO	Regulator output pin	
20	NC		

## **Block Diagram**



## **Equivalent Circuit Diagram**

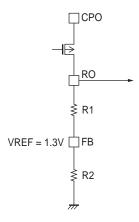


#### **Output Voltage Setting Method**

The output voltage of IC-incorporated LDO can be determined as follows:

$$VH = \frac{R1 + R2}{R2} \times VREF$$

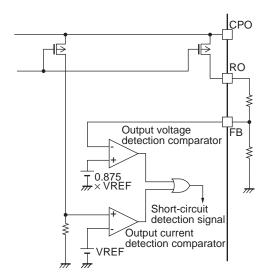
For example, to set the output voltage to 12V, set the resistance Value to  $R1 = 1070k\Omega/R2 = 130k\Omega$ .



## **Short-circuit Protective Operation**

The RO output pin has the short-circuit protective function.

The over-current detector circuit outputs the detection signal when the output current of 50mA (typ) or more flows or when the output voltage drops below 87.5% (typ). When this detection signal is output continuously for 18ms (typ) or more, IC determines that there is over-current and stops the output. To reset from the stop state, set the EN pin to "L", then set the EN pin to "H" again.



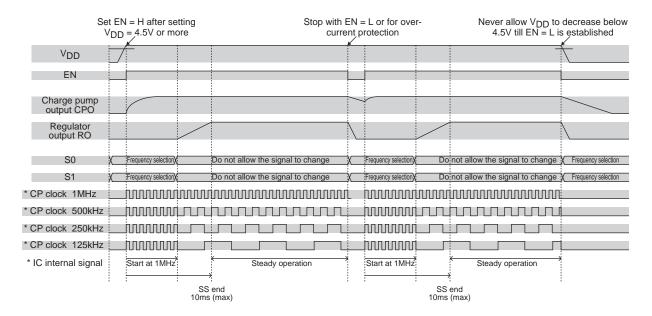
Equivalent circuit of the over-current detection circuit

#### **Selecting the Frequency**

According to the logic of S0 and S1, the charge pump operation frequency can be changed. In the case of light load, the reactive power can be reduced by decreasing the operating frequency.

S0	S1	CP operating frequency	
L	L	1MHz	
Н	L	500kHz	
L	Н	250kHz	
Н	Н	125kHz	

#### Startup sequence



#### **EN Pin and VDD**

The sequence operation is made at startup. However, startup is not made when the internal circuit has not been reset. To reset the internal circuit, keep the EN pin to "L" till  $V_{DD}$  becomes 4.5V or more. Note that  $V_{DD}$  and EN pin cannot be short-circuited for this purpose.

#### ORDERING INFORMATION

Device	Package	Shipping (Qty / Packing)
LV5710GP-TE-L-H	VCT20 3x3, 0.5P (Pb-Free / Halogen Free)	2000 / Tape & Reel

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